TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7USB31FK

Dual SPST USB Switch

TC7USB31 is high-speed CMOS dual SPST USB Switch. The low ON- resistance and the low capacitance of the switch allow connections to USB application.

The TC7USB31 requires the output enable (\overline{OE}) input to be set high to place the output into the high impedance.

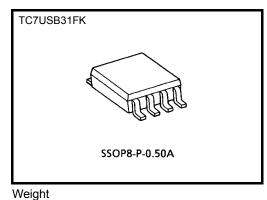
All inputs are equipped with protection circuits against static discharge.

Features

- Operating voltage: VCC = 2.3 to 3.6 V
- ON-capacitance: CI/O = 4 pF Switch ON (typ.)@V_{CC} = 3.3 V
- ON-resistance: $R_{ON} = 4.5 \Omega$ (typ.) @V_{CC} = 3 V, V_{I/O} = 0 V
- Ron Flatness: $Ron(flat) = 1.2 \Omega$ (typ.) @V_{CC} = 3 V
- Delta Ron: $\Delta Ron = 0.5 \Omega$ (typ.) @V_{CC} = 3 V
- ESD performance: Machine model $\geq \pm 200V$

Human body model $\geq \pm 2000 V$

- Power-down protection for inputs ($\overline{\text{OE}}$ and I/O)
- Package : US8

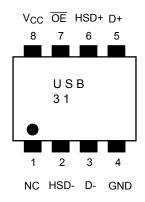


SSOP8-P-0.50A

: 0.01 g (typ)

Pin Assignment (top view)

FK (SSOP8-P-0.50A)

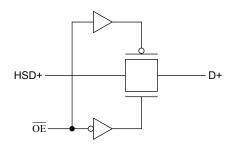


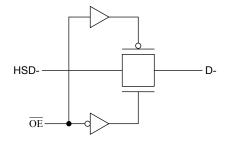
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Truth Table

Inputs	Function			
ŌĒ	- Function			
L	A port = B port			
Н	Disconnect			

System Diagram





Absolute Maximum Ratings (Note)

Charact	eristic	Symbol	Rating	Unit
Power supply range		V _{CC}	-0.5 to 4.6	V
Control pin input voltage	(OE)	VIN	-0.5 to 4.6	V
Switch terminal I/O voltage	V _{CC} =0V or Switch=Off	Vs	-0.5 to 4.6	V
Switch terminal I/O voltage	Switch=On	vs	–0.5 to V _{CC} +0.5	v
Clump diode current	Control input	Iк	-50	mA
	Switch		±50	ШA
Switch I/O current		IS	50	mA
Power dissipation		PD	200	mW
DC V _{CC} /GND current		I _{CC} /I _{GND}	±100	mA
Storage temperature		T _{stg}	–65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction. Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Charac	teristic	Symbol	Rating	Unit
Power supply voltage		V _{CC}	2.3 to 3.6	V
Control pin input voltage	(OE)	VIN	0 to 3.6	V
Switch I/O voltage	V _{CC} =0V or Switch=Off		0 to 3.6	V
	Switch=On	VS	0 to V _{CC}	v
Operating temperature		T _{opr}	-40 to 85	°C
Input rise and fall time		dt/dv	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Input voltage ^{"H"} level (OE) "L" level	"H" level	VIH	—	2.3 to 3.6	$0.46 \times V_{CC}$	_	_	V
	"L" level	VIL	—	2.3 to 3.6	_	_	$0.25 \times V_{CC}$	v
Input leakage current		I _{IN}	$V_{IN} = 0$ to 3.6 V	2.3 to 3.6		_	±1.0	μA
Power-off leakage	Power-off leakage current		V _{IN} = 0 to 3.6 V	0	_	_	±5.0	μA
Off-state leakage current (switch off)		I _{SZ}	$V_{IS} = 0$ to V_{CC} , $\overline{OE} = V_{CC}$	2.3 to 3.6	_	_	±5.0	μΑ
			$V_{IS} = 0 V, I_{IS} = 30 mA$ (Note 1)	3.0		4.5	9	
ON resistance	(Note 2)	R _{ON}	$V_{IS} = 0.4 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note 1)	3.0	_	5	9.5	Ω
(Note 2)			$V_{IS} = 3.0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note 1)	3.0		11	18	
Delta R_{ON} ΔR_{ON}		ΔR_{ON}	$V_{IS} = 0.4 \text{ V}, 1.0 \text{ V}, I_{IS} = 30 \text{ mA}$	3.0	_	0.5	_	Ω
On-Resistance Flatness RON(flat		R _{ON(flat)}	V_{IN} = 0 V to 1.0 V, I_{IS} = 30 mA	3.0	_	1.2	_	Ω
Quiescent supply current I _{CC}		ICC	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	3.6	_	_	2.0	μA
Increase in I _{CC} per input		ΔI_{CC}	V _{IN} = 1.8 V	3.6	—	_	10.0	μA

Note 1: All typical values are at Ta = 25°C.

Note 2: Measured by the voltage drop between D+/D- and HSD+/HSD- pins at the indicated current through the switch. ON resistance is determined by the lower of the voltages on the two pins.

AC Characteristics V_{CC} = 3.3V ± 10% (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation Delay Time (Note)	tpd	C _L =5pF	$\textbf{3.3}\pm\textbf{0.3}$	_	0.25	_	ns
Turn ON Time (\overline{OE} to Output)	t _{ON}	R _L =50Ω, C _L =5pF	$\textbf{3.3}\pm\textbf{0.3}$	—	4	10	ns
Turn OFF Time (\overline{OE} to Output)	tOFF	R _L =50Ω, C _L =5pF	$\textbf{3.3}\pm\textbf{0.3}$	_	3.2	9	ns
Output skew between center port to any other port (Note)	tsk(O)	C _L =5pF	$\textbf{3.3}\pm\textbf{0.3}$	_	0.1	_	ns
Skew of Opposite Transitions of the same output (t_{pHL} - t_{pLH}) (Note)	t _{SK(P)}	CL=5pF	$\textbf{3.3}\pm\textbf{0.3}$	—	0.1		ns
Off Isolation (Non-Adjacent)	OIRR	R _T =50Ω, f=240MHz	$\textbf{3.3}\pm\textbf{0.3}$	_	-27	_	dB
Crosstalk(Non-Adjacent)	XTalk	R _T =50Ω, f=240MHz	$\textbf{3.3}\pm\textbf{0.3}$	_	-60	_	dB
-3dB Bandwidth	BW	R _T =50Ω, C _L =0pF	3.3 ± 0.3	—	1100		MHz

Note: This parameter is guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Тур.	Unit
Control pin input capacitance (\overline{OE})	C _{IN}	$V_{IN} = 0 V$	(Note)	3.3	4	pF
Switch terminal Off capacitance	C _{I/O}	$V_{IS} = 0 V, \overline{OE} = V_{CC}$	(Note)	3.3	2	pF
Switch terminal On capacitance	C _{I/O}	$V_{IS} = 0 V, \overline{OE} = GND$	(Note)	3.3	4	pF

Note: This parameter is guaranteed by design.

AC Test Circuit Load / Waveform

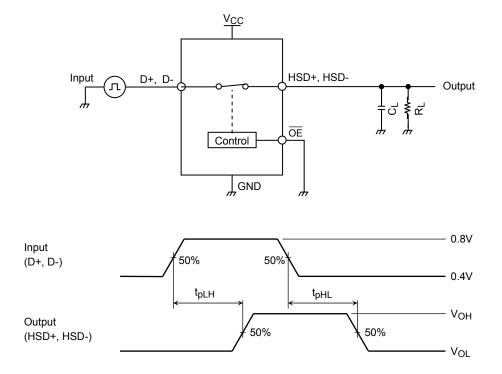


Figure 1: Propagation Delay Time (tpLH, tpHL)

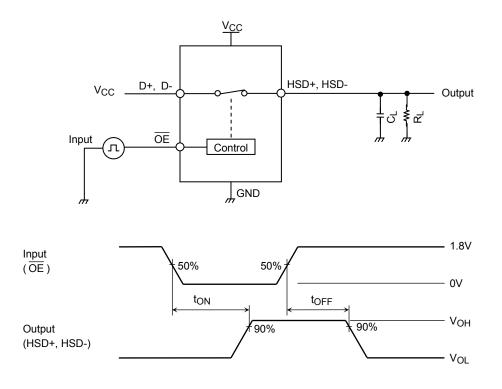
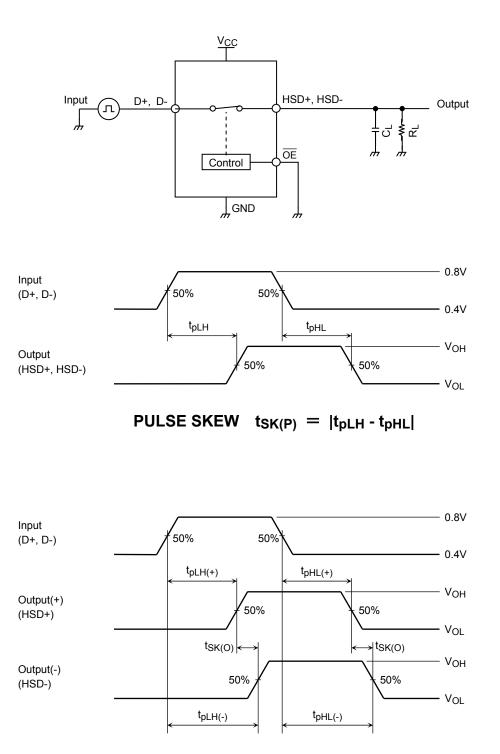
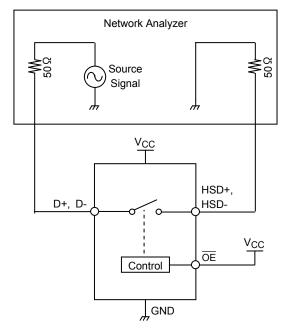


Figure 2: Turn ON/Turn OFF (ton, toff)



OUTPUT SKEW $t_{SK(O)} = |t_{pLH(+)} - t_{pLH(-)}|$ or $|t_{pHL(+)} - t_{pHL(-)}|$

Figure 3: Skew of Opposite Transitions of the same output, Output skew



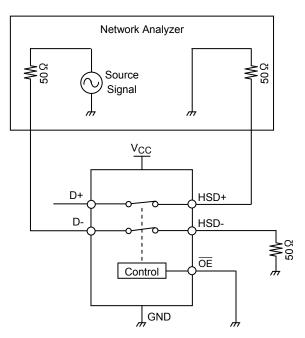


Figure 4: Channel OFF Isolation

Figure 5: Crosstalk

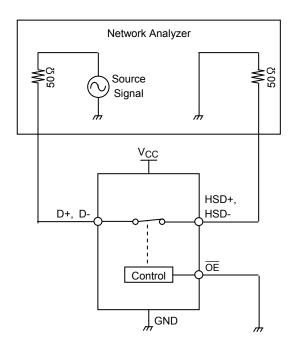


Figure 6: -3dB Bandwidth

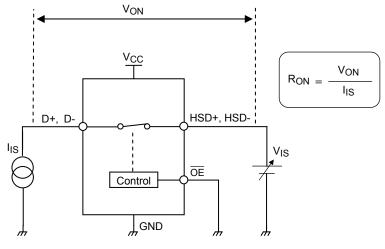


Figure 7: ON Resistance

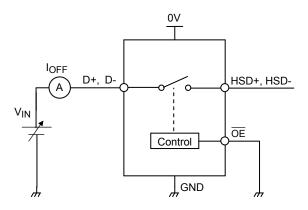


Figure 8: Power off Leakage Current

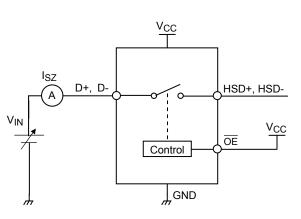
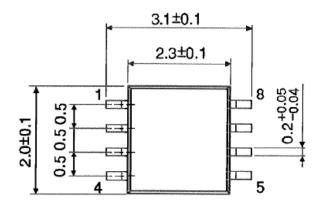


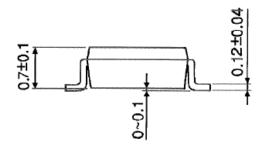
Figure 9: Off-State Leakage Current

Package Dimension

SSOP8-P-0.50A

Unit : mm





Weight: 0.01 g (Typ.)

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